

Page 1 of 2 Attorney Docket No. 8586

As a below named inventor, I hereby declare that:

My residence, mailing address and citizenship are as stated below next to my name.

(if planar names are listed below	v) of the subject matter which is c	one name is listed below) or an claimed and for which a patent is s	aught on the invention of the	
(check [X]	is attached hereto.	and Delivery of Substances the spe	ecification of which	
one) []	was filed on	as United	States Application No. or	
	PCT International Application and was amended on	n Serial No.	· · · · · · · · · · · · · · · · · · ·	
		(if applicable)	~	
I hereby state that I have	reviewed and understand the cor	ntents of the above-identified spec	ification, including the claims.	
as amended by any amendment	referred to above.			
for continuation-in-part applicat	ions material information which is a	material to patentability as defined	in 37 C.F.R. §1.56, including	
and the national or PCT internat	ional filing date of the continuation	became available between the filir	ng date of the prior application	
I hereby claim foreign p	riority benefits under 35 U.S.C. §	119(a)-(d) or \$365(b) of any forei	gn application(s) for patent or	
inventor's certificate, or 9303(a)	of any PC1 International applica	tion which designated at least one	country other than the United	
states of America, fisted below :	and have also identified below an	v foreign application for patent or i	inventor's certificate or of and	
		the application on which priority is	claimed:	
Prior Foreign Application	<u>n(s)</u>	Pric	ority Claimed	
(Number)	(Country) (Day	04-41-04 ET D		
,		/Month/Year Filed) Ye	es No	
	June 17, 2001	e(e) of any United States provision	al application(s) listed below.	
Application Serial No.	Filing Date	Application Serial No. ed States application(s), or §3650	Filing Date	
paragraph of 35 U.S.C. §112, I a	cknowledge the duty to disclose:	w and, insofar as the subject matte International application in the information which is material to pay of the prior application and the	manner provided by the first	
U.S. Parent Application	PCT Parent	Parent Filing Date	Parent Patent Number	
Number	Number	(MM/DD/YYYY)	(If applicable)	
As named inventor I harshy ar			ć.	
application and transact all busin	ess in the Patent and Trademark C	associated with customer number Office connected therewith.		
SEND CORRESPONDENCE TO				
I hereby declare that all statemen	its made herein of my own know	ledge are true and that all stateme	ents made on information and	
belief are believed to be true; and	l Turther that these statements wer	e made with the knowledge that w	illful folgo etetemante and de-	
like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.				
- and the state of	Jeopardize the validity of the app	incation or any patent issued thereo	on.	
Full name of sole or first joint inv	entor <u>Ali Abdelaziz Alwattari</u>	_		
Inventor's signature	N. 11%.	10/17/01		
Desidence 7702 Tulone Desidence	W- 14 01 4504	Date		
Residence <u>7703 Tylers Reserve</u> , Citizenship <u>US</u>	Hamilton, Ohio 45011	<u> </u>		
Mailing Address 7703 Tylers Res	erve, Hamilton, Ohio 45011			
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F. II				
Full name of second joint invento Inventor's signature	Rajeev (NMN) Chhabra			
entor a signature		10/17/01		
Residence 12127 South Pine Dri	ve, #255, Sharonville, Ohio 4524	Date 1	•	
Citizenship <u>India</u>				
Mailing Address <u>12127 South Pir</u>	e Drive, #255, Sharonville, Ohio	45241		

Full name of second joint inventor, if any Marcia J. Holden	O
Full name of second joint inventor, if any Marcia J. Holden, Inventor's signature	(Ont 12.01
	Date
Residence 8656 Mount Hope Road, Harrison, Ohio 45030	
Citizenship US	
Mailing Address 8656 Mount Hope Road, Harrison, Ohio 45030	